503476322 09/11/2015

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
DAISUKE NISHIGUCHI	06/11/2015
MASAKAZU KAGEOKA	06/10/2015
TOSHIAKI MORIYA	06/08/2015
SATOSHI YAMASAKI	06/10/2015

RECEIVING PARTY DATA

Name:	MITSUI CHEMICALS, INC.	
Street Address:	5-2, HIGASHI-SHIMBASHI 1-CHOME, MINATO-KU	
City:	TOKYO	
State/Country:	JAPAN	
Postal Code:	105-7117	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14775367

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Email: millar@rankinhill.com

Correspondent Name: RANKIN, HILL & CLARK LLP
Address Line 1: 23755 LORAIN ROAD, SUITE 200
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ATTORNEY DOCKET NUMBER:	IKM-40058
NAME OF SUBMITTER:	KAZUTO ISHIHARA
SIGNATURE:	/Kazuto Ishihara/
DATE SIGNED:	09/11/2015

Total Attachments: 3

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PATENT 503476322 REEL: 036546 FRAME: 0323

ASSIGNMENT

For good and valuable consideration received of the hereinafter named assignee, receipt of which is hereby acknowledged, the undersigned

Daisuke NISHIGUCHI of Sakai-shi, Osaka, Japan Masakazu KAGEOKA of Kawasaki-shi, Kanagawa, Japan Toshiaki MORIYA of Sagamihara-shi, Kanagawa, Japan Satoshi YAMASAKI of Chiba-shi, Chiba, Japan

hereby sell and assign to MITSUI CHEMICALS, INC. having a place of business at 5-2, Higashi-Shimbashi 1-chome, Minato-ku, Tokyo 105-7117, Japan, its successors and assigns, the entire right, title and interest, so far as concerns the United States and the Territories and Possessions thereof and all foreign countries, in and to the inventions entitled

LOW-RESILIENCE POLYURETHANE FOAM AND PRODUCTION METHOD THEREOF

for which application for United States Letters Patent has been filed on September 11, 2015 under Serial No. 14/775367 or was executed by the undersigned on the date below and is being filed concurrently herewith, said application for United States Letters Patent, any and all other applications for Letters Patent on said inventions in countries foreign to the United States, including all divisional, renewal, substitute, continuation and Convention applications based in whole or in part upon said inventions or upon said applications, and any and all Letters Patent and reissues and extensions of Letters Patent granted for said inventions or upon said applications, and every priority right that is or may be predicated upon or arise from said inventions, said applications and said Letters Patent; said assignee being hereby authorized to file patent applications in any or all countries on any or all said inventions in the name of the undersigned or in the name of said assignee or otherwise as said assignee may deem advisable, under the International Convention or otherwise; the Commissioner of Patents and Trademarks of the United States of America and the empowered officials of all other governments being hereby authorized to issue or transfer all said Letters Patent to said assignee in accordance herewith; this assignment being under covenant, not only that full power to make the same is had by the undersigned, but also that such assigned right is not encumbered by any grant, license, or other right heretofore given, and that the undersigned will do all acts reasonably serving to assure that said inventions, patent applications and Letters Patent shall be held and enjoyed by said assignee as fully and entirely as the same could have been held and enjoyed by the undersigned if this assignment had not been made.

> PATENT REEL: 036546 FRAME: 0324

and particularly to execute and deliver to said assignee all lawful documents including petitions, specifications, oaths, assignments, invention disclaimers, and lawful affidavits in form and substance which may be requested by said assignee, to furnish said assignee with all facts relating to said inventions or the history thereof and any and all documents, photographs, models, samples or other physical exhibits which may be useful for establishing the facts of conception, disclosure and reduction to practice of said inventions, and to testify in any proceedings relating to said inventions, patent applications and Letters Patent.

The undersigned hereby appoint, request, and grant power to the following law firm to insert on this Assignment further identification which may be necessary or desirable in order to comply with the Rules of the U.S. Patent and Trademark Office for recordation of this document, for example, the U.S. Serial No. and filing date.

RANKIN, HILL & CLARK LLP, 23755 Lorain Road, Suite 200, North Olmsted, Ohio 44070-2224

Signed:	Date:
Daisuke Nishiguchi Daisuke NISHIGUCHI	6/11/2015
Signed:	Date:
Masakazu KAGEOKA	
Signed:	Date:
Toshiaki MORIYA	
Signed:	Date:

Satoshi YAMASAKI

PATENT REEL: 036546 FRAME: 0325 and particularly to execute and deliver to said assignee all lawful documents including petitions, specifications, oaths, assignments, invention disclaimers, and lawful affidavits in form and substance which may be requested by said assignee, to furnish said assignee with all facts relating to said inventions or the history thereof and any and all documents, photographs, models, samples or other physical exhibits which may be useful for establishing the facts of conception, disclosure and reduction to practice of said inventions, and to testify in any proceedings relating to said inventions, patent applications and Letters Patent.

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RANKIN, HILL & CLARK LLP, 23755 Lorain Road, Suite 200, North Olmsted, Ohio 44070-2224

Signed:	Date:
Daisuke NISHIGUCHI	
Signed:	Date:
Masakazu KAGEOKA	June 10, 2015
Signed:	Date:
Toshioki Moriya Toshiaki MORIYA	Jun. 8. 2015
Signed:	Date:
Satoshi Yamasahi Satoshi YAMASAKI	June, 10, 2015

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